

# Multilayer Thermionic Refrigeration

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## Abstract

A review is presented of our program to construct an efficient solid state refrigerator based on thermionic emission of electrons over periodic barriers in the solid. The experimental program is to construct a simple device with one barrier layer using a three layers: metal-semiconductor-metal. The theoretical program is doing calculations to determine: (i) the optimal layer thickness, and (ii) the thermal conductivity.

## 1 Introduction

Refrigeration using thermionic emission was proposed in 1994[1, 2]. The original concept had two metal plates separated by a vacuum or air. This device is practical at room temperature only if the metal electrodes have a low work function (0.3 eV) which is below any known value. So the vacuum device is impractical. A related concept is to have a multilayer solid, in which alternate layers serve as barriers to the flow of electrons[3, 4, 5, 6, 7]. Only energetic electrons surmount the barriers, which serves as an efficient energy filter. The electrical current is carried by the hot electrons, which leads to a high effective Seebeck coefficient. This concept is called Multi-

layer Thermionic Refrigeration.

## 2 Experimental Program

Several other research groups are investigating semiconductor multilayers for use as solid state refrigerators[8, 9, 10]. In these systems, the band offsets between successive layers serves as the periodic barriers. Our group has tried an alternate approach of having the multilayers be alternate layers of metals and semiconductors. In this case the Schottky barrier at the metal-semiconductor interface serves as the barrier to the flow of electrons. The semiconductor form the barrier layers.

My experimental colleagues (J. Bates, G. Kim, F. Modine, D. Norton, H. Weitering) have been trying to construct simple three layer devices of one semiconductor layers with two metal electrodes. There are several methods of making these thin film devices. Here we list them according to the ease of making films:

1. *Sputtering*: Satisfactory three layer systems were made by sputtering germanium between two metal electrodes. However, Ge has too high of a thermal conductivity to demonstrate solid state refrigeration. Numerous attempts were made to sputter binary semiconductors such as  $\text{Bi}_2\text{Te}_3$

or PbTe. Sputtering of binaries was unsuccessful. The films were of poor quality and contained large densities of defects. We are unaware of any successful attempt to create binary films by sputtering.

2. *Laser Ablation*: ORNL has a major facility in making films by laser ablation. Only oxide materials form well layered films using this technique. Reports in the literature suggested that  $\text{Cu}_2\text{O}$  and  $\text{BiBaO}_3$  both had small values of Schottky barriers with suitable metals. Three layer devices were made of these two materials using laser ablation. Our measurements showed that the resulting Schottky barriers were too high (0.7 eV) to serve as suitable thermionic refrigerators.
3. *Chemical Vapor Deposition*: This has not yet been tried.
4. *Molecular Beam Epitaxy*: Weiering and Kim have constructed an MBE machine to make films for thermionic refrigerators. Weiering is giving a talk on this work at this meeting.

So far the experimental work has been inconclusive. No device has yet been made which demonstrate efficient cooling.

### 3 Theoretical Considerations

#### 3.1 Layer Thickness

One crucial issue for the device efficiency is to select the appropriate thickness for the barrier layer. The proper choice depends upon ones view of how the device operates. Our view is that efficient cooling requires that the electrons ballistically traverse the barrier layer. Then there is a requirement that the layers

must be thinner than the mean-free-path of the electron ( $L < \ell_p$ ).

There are several definitions of mean-free-path (mfp): for momentum relaxation  $\ell_p$ , for energy relaxation  $\ell_E$  and for phase breaking  $\ell_\phi$ . Generally  $\ell_E \gg \ell_p$ . We believe that the relevant mfp to determine the barrier thickness is the one for momentum relaxation  $\ell_p$ . We have performed calculations at room temperature ( $T = 300$  K) of the mfp  $\ell_p$  for some common n-type semiconductors which have a single conduction band ellipsoid. The mean-free-path was limited by scattering by phonons and impurities. The phonon scattering gave values of the mfp on the order of micrometers. The scattering by impurities gave values of the mfp on the order of 10-100 nm. Since impurity scattering gives the small value, it dominates the answer. The most probable value of  $\ell_p \sim 5a_B^*$ , where  $a_B^*$  is the effective Bohr radius of an electron bound to a donor in the semiconductor. This result is remarkably independent of the concentration of impurities.

Similar calculations have been done for the mfp of phonons, and for the distribution of mfps. Some results will be shown.

#### 3.2 B-Factor

In thermoelectrics the *B-Factor* is a dimensionless number (called  $B_{TE}$ ) which determines the efficiency of thermoelectrics[11]. Vining and Mahan[12] showed that there is an equivalent B-Factor for thermionic refrigeration (called  $B_{TI}$ ). These two are

$$B_{TI} = \frac{m^* k_B (k_B T)^2 L}{2\pi^2 \hbar^3 K_{SL}} \quad (1)$$

$$B_{TE} = \frac{m^* k_B (k_B T)^2 \ell_p}{2\pi^{3/2} \hbar^3 K_{SL}} \quad (2)$$

$$\ell_p = \tau v_p = \tau \sqrt{\frac{2k_B T}{m^*}} \quad (3)$$

$$\frac{B_{TI}}{B_{TE}} = \frac{L}{\ell_p \sqrt{\pi}} \quad (4)$$

and  $b = e\phi/k_B T$  where  $e\phi$  is the work function in thermionic emission. Given that  $L < \ell_p$  according to our prior discussion, then the B-factor ( $B_{TI}$ ) for thermionic emission is always less than that for thermoelectrics. Since the larger B gives the larger efficiency[11], then a thermoelectric device is more efficient than a thermionic device if they have the same thermal conductivity.

### 3.3 Thermal Conductivity

All solid state refrigerators require a low value of the thermal conductivity for efficient operation[11]. It is possible that a multilayer system has a lower thermal conductivity than a pure material[8, 13, 14, 15, 16, 17, 18, 19, 20]. This result has been found in early experiments, and has been predicted by calculations. Here we confine the discussion to thermal conductivity along the  $c$ -axis, which is perpendicular to the plane of the layers. We have done calculations which show that there is an optimal thickness of the layers in order to have a minimum thermal conductivity. In this case the important parameter, which determines the minimum layer thickness, is the phonon mfp. There are two different methods of calculating the thermal conductivity of superlattices, and they give dramatically different answers. They are the classical or particle theory, and the wave theory.

The classical theory includes the interface boundary resistance[21]. A superlattice with alternating layers of thickness  $L_{1,2}$  has a thermal resistance for one repeat unit

$$R_{SL} = L_1/K_1 + L_2/K_2 + 2R_B \quad (5)$$

$$K_{SL} = \frac{2L}{R_{SL}} = \frac{2L}{L(1/K_1 + 1/K_2) + 2R_B} \quad (6)$$

where  $K_j$  is thermal conductivity of the individual layers, and  $R_B$  is the thermal boundary

resistance. Assume that  $L_1 = L_2 \equiv L$ . The effective thermal conductivity of the superlattice is  $K_{SL}$ . This classical prediction is that the thermal conductivity decreases as the layer thickness  $L$  decreases[20]. The same result is obtained by solving the Boltzmann equation for the transport. Boltzmann equation treats the phonons as particles which scatter from the boundaries. Wave phenomena is ignored.

The wave theory calculates the actual phonon modes  $\omega_\lambda(\mathbf{k})$  of the superlattice, where  $\lambda$  is the band index. They are used to calculate the thermal conductivity from the usual formula in  $d$ -dimensions[22]

$$K(T) = \sum_\lambda \int \frac{d^d k}{(2\pi)^d} \hbar \omega_\lambda(\mathbf{k}) |v_z(\mathbf{k})| \ell(\mathbf{k}) \frac{\partial n(\omega, T)}{\partial T}$$

where  $\ell(\mathbf{k})$  is the phonon mfp and  $n(\omega, T)$  is the Bose-Einstein distribution function. At high temperatures, approximate  $n \sim k_B T / \hbar \omega_\lambda(\mathbf{k})$  which gives

$$K(T) = k_B \sum_\lambda \int \frac{d^d k}{(2\pi)^d} |v_z(\mathbf{k})| \ell(\mathbf{k}) \quad (7)$$

The above formula is quite general. Two important special cases of constant relaxation time ( $K_\tau$ ) and constant mfp ( $K_\ell$ ) are

$$K_\tau(T) = k_B \tau \sum_\lambda \int \frac{d^d k}{(2\pi)^d} v_z(\mathbf{k})^2 \quad (8)$$

$$K_\ell(T) = k_B \ell \sum_\lambda \int \frac{d^d k}{(2\pi)^d} |v_z(\mathbf{k})| \quad (9)$$

Wave interference leads to band folding[23, 24], which leads to a reduction of the phonon velocities. Both  $K_\tau$  and  $K_\ell$  are reduced by wave interference.

These assertions are best illustrated in one dimension, for the atomic chain. Our model[25] for a superlattice has all spring constants identical, and the layers differ in their

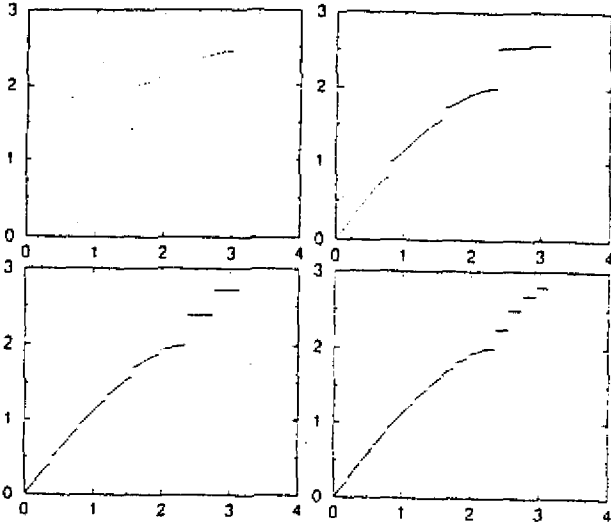


Figure 1: Spectrum of  $N = 2, 4, 8, 16$  superlattices with mass ratio  $\alpha = 2$  in the extended zone representation.

masses. For a repeat distance of  $N$ -layers, one layer has  $N/2$  atoms of mass  $m_1$  and the other layer has  $N/2$  atoms of mass  $m_2 = m_1/\alpha$ . The characteristic equation  $k(\omega)$  of the normal modes is [25]

$$\cos(kN) = \cos(k_1 N/2) \cos(k_2 N/2) - \frac{1 - \cos(k_1) \cos(k_2)}{\sin(k_1) \sin(k_2)} \sin(k_1 N/2) \sin(k_2 N/2) \quad (10)$$

where  $\cos(k_1) = 1 - \omega^2/2$ ,  $\cos(k_2) = 1 - \omega^2/(2\alpha)$  define the wave vectors  $(k_1, k_2)$  in the individual layers in dimensionless units. A typical spectrum is shown in Fig.1, where  $\alpha = 2$  and the SL periods are  $N = 2, 4, 8, 16$ . Modes with frequency  $\omega > 2$  are confined within the layer of the lighter atom, and contribute little to the thermal conduction. As the value of  $N$  is increased in Fig. 1, there is more band folding, and the average velocity decreases. Fig.2 shows the thermal conductivity as a function of superlattice period[25, 26, 27] The result for constant mfp is normalized to  $k_B \ell \omega_{2,\max}$ , where  $\omega_{2,\max} = 2$  is the maximum phonon frequency in the layer 1 of heavy mass. The heat This result is for one dimension. Similar curves are found for every case which we have

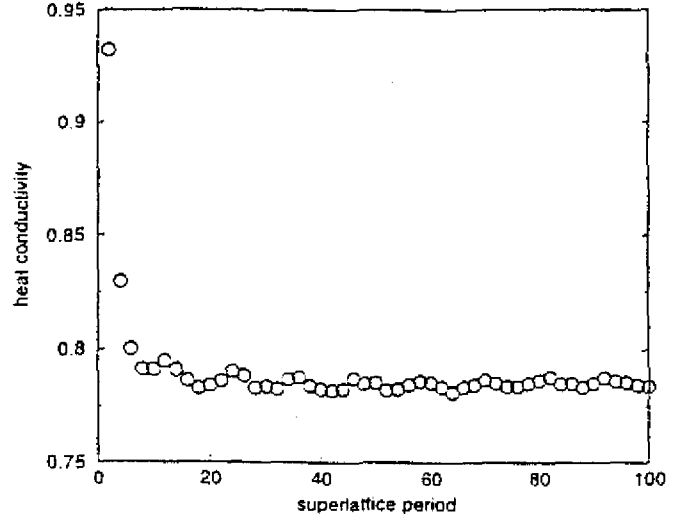


Figure 2: Heat conductivity in one dimension as a function of superlattice period for mass ratio  $\alpha = 2$ . Dimensionless units found by dividing (11) by  $2k_B \ell$ .

calculated: for different values of mass ratio  $\alpha$ , and for both  $K_\ell$  and  $K_\tau$ . Generally, increasing  $N$ : (i) increases the amount of band folding, (ii) decreases the average velocity in the SL, and (iii) decreases the thermal conductivity. Similar calculations of  $K_\ell$  in two and three dimensions show the same result that the thermal conductivity declines with increasing  $N$ , for all values of  $\alpha$ [25].

The two methods of calculation of the thermal conductivity, by boundary resistance and by band folding, give opposite predictions for the thermal conductivity as a function of layer thickness. The two viewpoints are reconciled by including the mfp in the calculations. When the layer thickness exceeds the mfp, then interference effects should diminish, and the particle model should become applicable. The wave model should apply when  $L < \ell$  and the particle model should apply when  $L > \ell$ . The mfp  $\ell$  is added to the calculation of the heat transport by including a complex part to the wave vectors  $k_{1,2}$ , which is  $i/\ell$ . The properties of the superlattice are calculated using eqn.(10)but now including the imaginary part

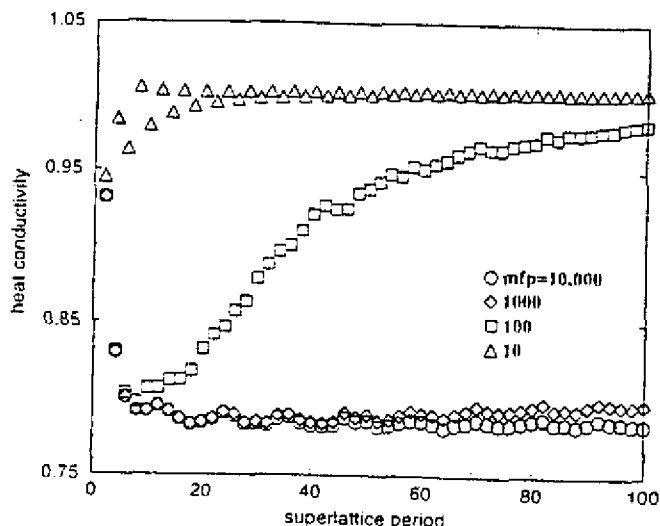


Figure 3: Thermal conductivity in one dimension as a function of superlattice period for mass ratio  $\alpha = 2$  for different values of the phonon mfp which is given in units of lattice periods.

of  $K_{1,2}$ . Making  $k_{1,2}$  complex makes  $k$  complex, and the effective wave vector is its real part. The band folding is found to diminish as the mfp is decreased for a fixed value of  $N$ [25].

Fig.3 shows the thermal conductivity in one dimension as a function of SL period for four different values of mfp and  $\alpha = 2$ . The mfp is given in terms of the number of lattice spacings (note: not SL spacings). Similar curves are found for other values of  $\alpha$ . For large values of  $\ell$  the results are identical to figure 2 (which had  $\ell = \infty$ ). For small values of mfp ( $\ell = 10$ ) the thermal conductivity is nearly independent of SL period, except where it falls at small values of  $N$ . This reduction is probably due to thermal boundary resistance. Using eqn.(1) shows a very small value of boundary resistance  $R_B$ . For  $\ell = 100$  the thermal conductivity falls as  $N$  increases, reaches a minimum, and then starts to increase. This latter behavior is the situation expected in the experiments. At room temperature, in most solids, anharmonic scattering limits the phonon mfp value in the range of 10-100 lattice con-

stants, which is also the typical value of SL parameter in current devices. Therefore we expect the experimental thermal conductivities to behave as the curve marked  $\ell = 100$  in fig.3. The thermal conductivity should have a minimum value when plotted vs. SL period. The minimum occurs at the cross over between the particle and wave-interference types of transport. One experimental result has this behavior[8].

## 4 Conclusion

We have considered the experimental variables which determine the optimal operation of a multilayer refrigerator based upon thermionic emission. The barrier thickness will be determined by the minimum in the thermal conductivity, which is determined by the phonon mfp. The phonon mfp is generally shorter than the mfp of the electron. The optimal barrier thicknesses will be quite short, on the order of nanometers rather than hundreds of nanometers. This value is much shorter than the mfp of the electron, so that the electrons are safely in the ballistic regime. For these very short barriers the multilayer thermionic refrigerator may not be very efficient, since its B-factor is relatively small.

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